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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/050,334
Filing Date January 15, 2002
Inventor Vishnu K. Agarwal
Assignee Micron Technology, Inc.
Group Art Unit 2813
Examiner Tuan H. Nguyen
Attorney's Docket No. MI22-1913
Title: Capacitor Fabrication Methods and Capacitor Constructions and
Enhanced Surface

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT


References – See Attached Form PTO-1449

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 18 Aug 2006

By: 
James E. Lake
Reg. No. 44,854

AUG 18 2006

Sheet 1 of 1

Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			ATTY. DOCKET NO. MI22-1913		SERIAL NO. 10/050,334	
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)					APPLICANT: Vishnu K. Agarwal			
					FILING DATE January 15, 2002		GROUP 2813	
U.S. PATENT DOCUMENTS								
Examiner's Initials		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	6,207,561	03/2001	Hwang et al.				
	AB	5,006,956	04/1991	Kawakita et al.				
	AC	6,730,163	05/2004	Vaartstra				
	AD	6,809,212	10/2004	Meiere et al.				
	AE	6,881,260	04/2005	Marsh et al.				
	AF	7,018,469	03/2006	Li et al.				
	AG							
	AH							
	AI							
FOREIGN PATENT DOCUMENTS								
		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AJ							
	AK							
	AL							
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)								
	AM							
	AN							
	AO							
EXAMINER		DATE CONSIDERED						
<small>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small>								